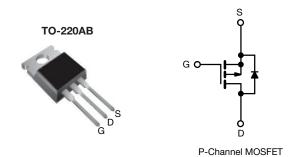
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-100			
$R_{DS(on)}(\Omega)$	V _{GS} = -10 V 0.30			
Q _g max. (nC)	38			
Q _{gs} (nC)	6.8			
Q _{gd} (nC)	21			
Configuration	Single			



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Lead (Pb)-free	IRF9530PbF	
Lead (FD)-II ee	SiHF9530-E3	
SnPb	IRF9530	
SIFU	SiHF9530	

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	-100	.,	
Gate-Source Voltage		V_{GS}	± 20	V	
Continuous Drain Current	V_{GS} at - 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D -	- 12		
Continuous Drain Current	V_{GS} at - 10 V $T_{C} = 100 ^{\circ}\text{C}$		-8.2	A	
Pulsed Drain Current a		I _{DM}	-48	1	
Linear Derating Factor			0.59	W/°C	
Single Pulse Avalanche Energy b		E _{AS}	400	mJ	
Repetitive Avalanche Current ^a		I _{AR}	-12	А	
Repetitive Avalanche Energy ^a		E _{AR}	8.8	mJ	
Maximum Power Dissipation	T _C = 25 °C		88	W	
Peak Diode Recovery dV/dt ^c		dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C	
Soldering Recommendations (Peak temperature) d for 10 s			300		
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting Torque	0-32 OF IVIS SCIEW		1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=$ -25 V, starting $T_J=$ 25 °C, L= 4.2 mH, $R_g=$ 25 Ω , $I_{AS}=$ -12 A (see fig. 12). c. $I_{SD}\leq$ -12 A, $dI/dt\leq$ 140 A/ μ s, $V_{DD}\leq$ V_{DS} , $T_J\leq$ 175 °C.
- d. 1.6 mm from case.



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7	

SPECIFICATIONS (T _J = 25 °C, u	SYMBOL	1	CONDITIONS	MINI	TVD	MAY	LINUT
PARAMETER	STMBOL	IESI	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		T			ı	1	ı
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$) V, I _D = -250 μA	-100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = -1 mA	-	-0.10	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V$	/ _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I_{GSS}	Vo	_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = -$	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		-	-100	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -80 \text{ V},$	V _{GS} = 0 V, T _J = 150 °C	-	-	-500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -7.2 A ^b	-	-	0.30	Ω
Forward Transconductance	9fs	$V_{DS} = -5$	50 V, I _D = -7.2 A ^b	3.7	-	-	S
Dynamic						•	,
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	860	-	
Output Capacitance	C _{oss}		$V_{GS} = 0 \text{ V},$ $DS = -25 \text{ V},$	-	340	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5	-	93	-	1
Total Gate Charge	Qq		I _D = -12 A, V _{DS} = -80 V, see fig. 6 and 13 ^b	-	-	38	nC
Gate-Source Charge	Q _{gs}	V _{GS} = -10 V		-	-	6.8	
Gate-Drain Charge	Q_{gd}	1	see lig. o and 15	-	-	21	
Turn-On Delay Time	t _{d(on)}		1	-	12	-	
Rise Time	t _r	V_{DD} = -50 V, I_{D} = -12 A, R_{g} = 12 Ω , R_{D} = 3.9 Ω , see fig. 10 ^b		-	52	-	ns
Turn-Off Delay Time	t _{d(off)}			-	31	-	
Fall Time	t _f	1		-	39	-	
Internal Drain Inductance	L _D	, ,	Between lead, 6 mm (0.25") from		4.5	-	- nH
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	
Gate Input Resistance	R_g	f = 1 MHz, open drain		0.4	-	3.3	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		1	-	-12	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p -n junction di	G \ 1 /	-	-	-48	
Body Diode Voltage	V_{SD}	T _J = 25 °C, I	_S = -12 A, V _{GS} = 0 V ^b	-	-	-6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T ₁ = 25 °C J ₂ =	-12 A, dl/dt = 100 A/µs b	_	120	240	ns
Body Diode Reverse Recovery Charge	Q_{rr}	1J - 20 O, 1F =	12 A, al/at - 100 A/µ8	-	0.46	0.92	μC
Forward Turn-On Time	t _{on}	Intrinsic turr	n-on time is negligible (turn	-on is dor	minated b	y L _S and	L_D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

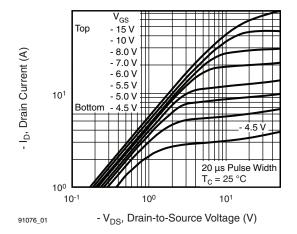


Fig. 1 -Typical Output Characteristics, T_C = 25 °C

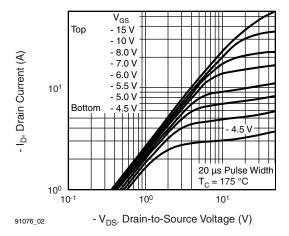


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

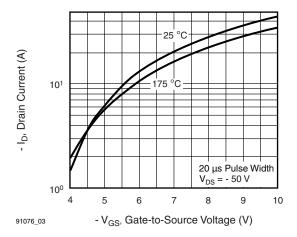


Fig. 3 - Typical Transfer Characteristics

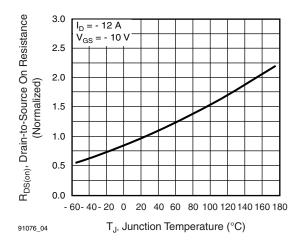


Fig. 4 -Normalized On-Resistance vs. Temperature

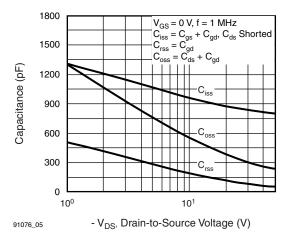


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

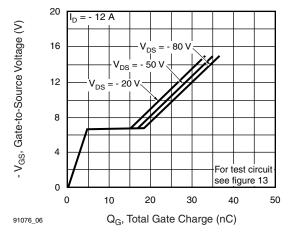


Fig. 6 -Typical Gate Charge vs. Gate-to-Source Voltage



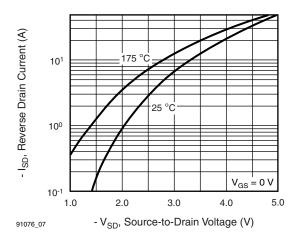


Fig. 7 - Typical Source-Drain Diode Forward Voltage

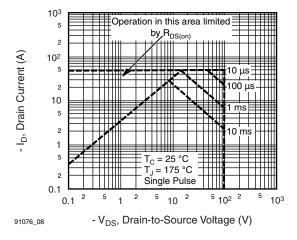


Fig. 8 - Maximum Safe Operating Area

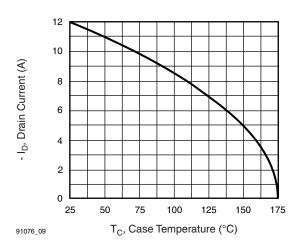


Fig. 9 - Maximum Drain Current vs. Case Temperature

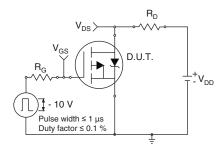


Fig. 10a - Switching Time Test Circuit

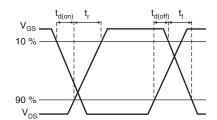


Fig. 10b - Switching Time Waveforms

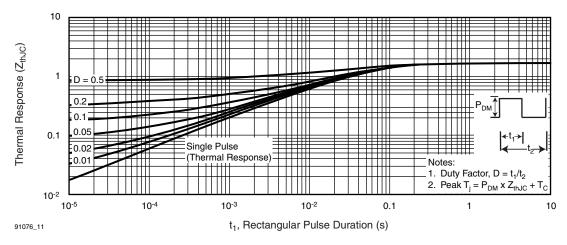


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



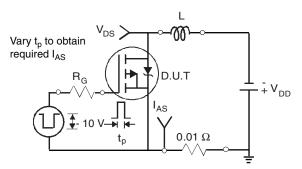


Fig. 12a - Unclamped Inductive Test Circuit

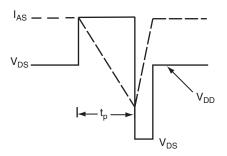


Fig. 12b - Unclamped Inductive Waveforms

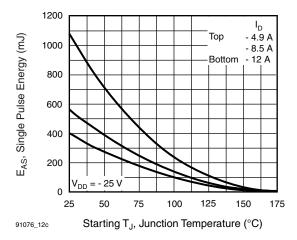


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

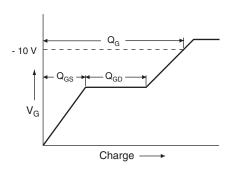


Fig. 13a - Basic Gate Charge Waveform

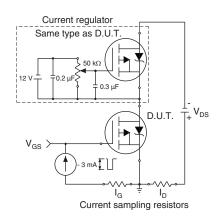
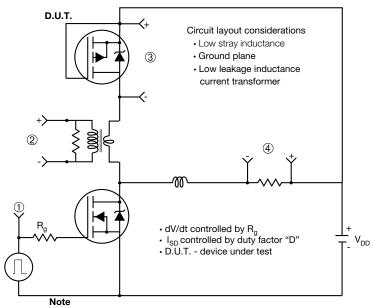


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

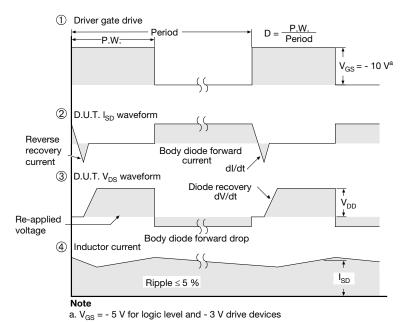


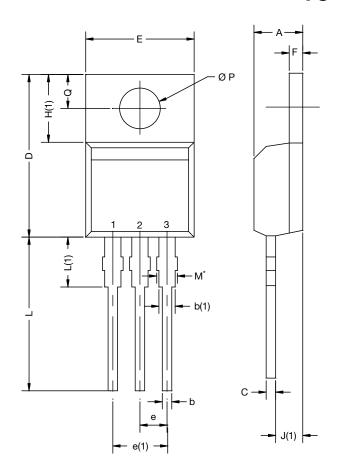
Fig. 14 -For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91076.





TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D

TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C

IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI

DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384

NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956

NTE2911 US6M2GTR TK10A80W,S4X(S SSM6P69NU,LF